TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

## TC74VHC273F,TC74VHC273FT,TC74VHC273FK

#### Octal D-Type Flip-Flop with Clear

The TC74VHC273 is an advanced high speed CMOS OCTAL D-TYPE FLIP FLOP fabricated with silicon gate  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

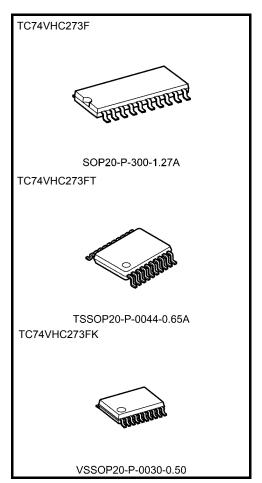
Information signals applied to D inputs are transferred to the Q outputs on the positive going edge of the clock pulse.

When the  $\overline{\text{CLR}}$  input is held "L", the Q outputs are at a low logic level independent of the other inputs.

An input protection circuit ensures that 0 to 5.5~V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5~V to 3~V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

#### **Features**

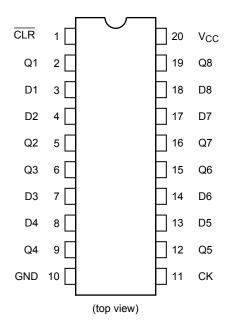
- High speed:  $f_{max} = 165 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range:  $V_{CC \text{ (opr)}} = 2 \text{ to } 5.5 \text{ V}$
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with 74ALS273



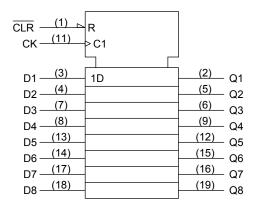
Weight

SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

### **Pin Assignment**



## **IEC Logic Symbol**

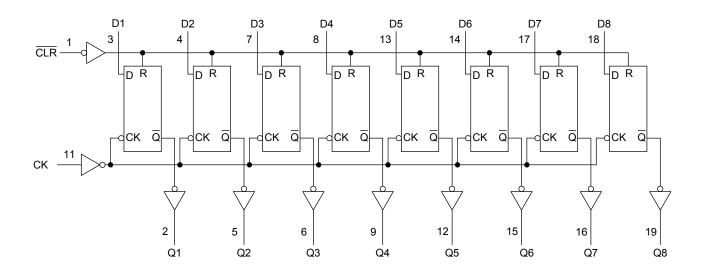


**Truth Table** 

	Inputs		Output	Function
CLR	D	СК	Q	Function
L	Х	Х	L	Clear
Н	L		L	_
Н	Н		Н	_
Н	Х	$\neg$	$Q_n$	No Change

X: Don't care

## **System Diagram**





#### **Absolute Maximum Ratings (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	−0.5 to 7.0	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	-20	mA
Output diode current	I <sub>ok</sub>	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	Icc	±75	mA
Power dissipation	PD	180	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to 5.5	٧
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	<b>V</b>
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 100 ( $V_{CC} = 3.3 \pm 0.3 \text{ V}$ ) 0 to 20 ( $V_{CC} = 5 \pm 0.5 \text{ V}$ )	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

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### **Electrical Characteristics**

### **DC Characteristics**

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
	, , , ,		V <sub>CC</sub> (V)		Min	Тур.	Max	Min	Max	
High-level input		_		2.0	1.50	_	_	1.50	_	V
voltage	V <sub>IH</sub>			3.0 to 5.5	V <sub>CC</sub> × 0.7	_	_	V <sub>CC</sub> × 0.7	_	
Low-level input				2.0	_	_	0.50	_	0.50	
voltage	$V_{IL}$	_		3.0 to 5.5	_	_	V <sub>CC</sub> × 0.3	_	V <sub>CC</sub> × 0.3	V
	Vон			2.0	1.9	2.0	_	1.9	_	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	Ι <sub>ΟΗ</sub> = -50 μΑ	3.0	2.9	3.0	_	2.9	_	V
High-level output voltage				4.5	4.4	4.5	_	4.4		
			$I_{OH} = -4 \text{ mA}$	3.0	2.58	_	_	2.48	_	
			$I_{OH} = -8 \text{ mA}$	4.5	3.94	_	_	3.80	_	
	V <sub>OL</sub>			2.0	_	0.0	0.1	_	0.1	
		VIN = VIH or VIL	I <sub>OL</sub> = 50 μA	3.0	_	0.0	0.1	_	0.1	
Low-level output voltage				4.5	_	0.0	0.1	_	0.1	V
			I <sub>OL</sub> = 4 mA	3.0	_	_	0.36	_	0.44	
			I <sub>OL</sub> = 8 mA	4.5	_	_	0.36	_	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5			±0.1		±1.0	μА
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or	GND	5.5	_	_	4.0	_	40.0	μА

# Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40 to 85°C	Unit
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width (CK)	t <sub>w (L)</sub>		$3.3 \pm 0.3$	_	5.5	6.5	ns
Millimum puise width (CK)	t <sub>w (H)</sub>	_	$5.0 \pm 0.5$	_	5.0	5.0	
Minimum pulse width ( CLR )	t <sub>w (L)</sub>	_	$3.3 \pm 0.3$	_	5.0	6.0	ns
Millimum puise width ( CER )			$5.0 \pm 0.5$	_	5.0	5.0	
Minimum set-up time	t <sub>s</sub>	_	$3.3 \pm 0.3$	_	5.5	6.5	ns
wiriimum set-up time			$5.0 \pm 0.5$	_	4.5	4.5	
Minimum hold time	t <sub>h</sub>	_	$3.3 \pm 0.3$	_	1.0	1.0	20
Willimum floid time			$5.0 \pm 0.5$	_	1.0	1.0	ns
Minimum removal time ( CLR )			$3.3\pm0.3$	_	2.5	2.5	20
William Temoval (IIIIe ( CLR )	t <sub>rem</sub>		$5.0 \pm 0.5$	_	2.0	2.0	ns



#### AC Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Tes	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	- J		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	
			3.3 ± 0.3	15	_	8.7	13.6	1.0	16.0	ns
Propagation delay time	$t_{pLH}$			50	_	11.2	17.1	1.0	19.5	
(CK-Q)	$t_{pHL}$	_	5.0 ± 0.5	15	_	5.8	9.0	1.0	10.5	115
,			5.0 ± 0.5	50	_	7.3	11.0	1.0	12.5	
			3.3 ± 0.3	15	_	8.9	13.6	1.0	16.0	
Propagation delay time	t <sub>pHL</sub>	_	3.3 ± 0.3	50	_	11.4	17.1	1.0	19.5	ns
( CLR -Q)			5.0 ± 0.5	15	_	5.2	8.5	1.0	10.0	
,				50	_	6.7	10.5	1.0	12.0	
	f <sub>max</sub>	_	3.3 ± 0.3	15	75	120	_	65	_	- MHz
Maximum clock				50	50	75	_	45	_	
frequency			5.0 ± 0.5	15	120	165	_	100	_	
				50	80	110	_	70	_	
Output to output akow	t <sub>osLH</sub>	(Note 1)	$3.3 \pm 0.3$	50	_	_	1.5	_	1.5	ns
Output to output skew	t <sub>osHL</sub>	(Note 1)	5.0 ± 0.5	50	_	_	1.0	_	1.0	
Input capacitance	C <sub>IN</sub>		_		_	4	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note 2)	_	31	_	_	_	pF

Note 1: Parameter guaranteed by design.

 $t_{OSLH} = |t_{pLHm} - t_{pLHn}|, t_{OSHL} = |t_{pHLm} - t_{pHLn}|$ 

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

And the total  $C_{\mbox{\scriptsize PD}}$  when n pcs.of flip flop operate can be gained by the following equation:

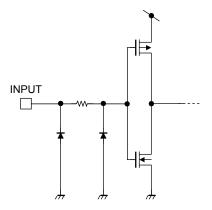
 $C_{PD}$  (total) = 22 + 9·n

#### Noise Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	_	Ta = 25°C		Unit
Characteristics	Symbol		V <sub>CC</sub> (V)	Тур.	Max	Offic
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.5	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	$V_{OLV}$	C <sub>L</sub> = 50 pF	5.0	-0.5	-0.8	>
Minimum high level dynamic input voltage	$V_{IHD}$	C <sub>L</sub> = 50 pF	5.0	_	3.5	٧
Maximum low level dynamic input voltage	$V_{ILD}$	C <sub>L</sub> = 50 pF	5.0	_	1.5	<b>V</b>



# **Input Equivalent Circuit**

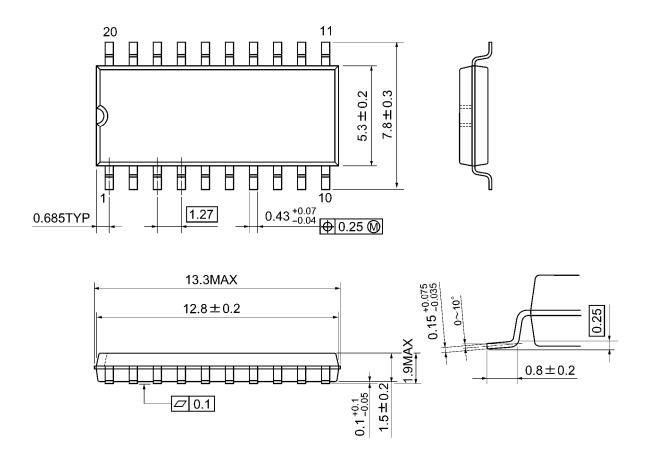


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## **Package Dimensions**

SOP20-P-300-1.27A Unit: mm

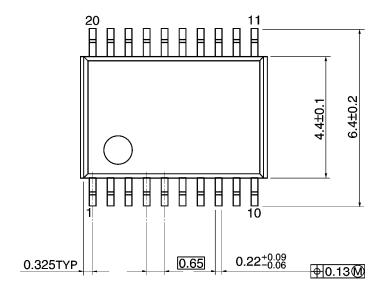


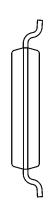
Weight: 0.22 g (typ.)

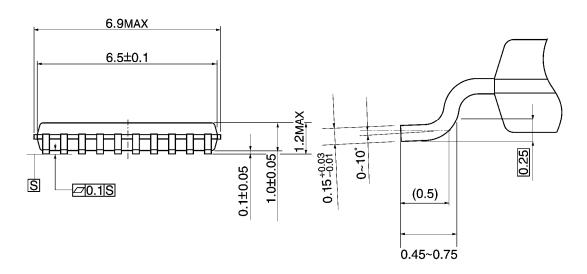
## **Package Dimensions**

TSSOP20-P-0044-0.65A

Unit: mm





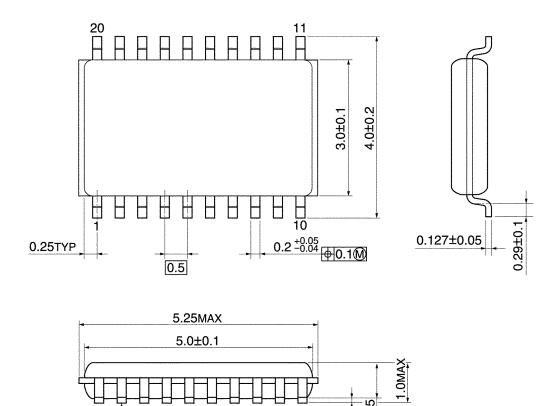


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Weight: 0.08 g (typ.)

## **Package Dimensions**

VSSOP20-P-0030-0.50 Unit: mm



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0.1±0.05

Weight: 0.03 g (typ.)

**270.1** 

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